Hindawi Publishing Corporation Advances in Power Electronics Volume 2016, Article ID 4705709, 9 pages http://dx.doi.org/10.1155/2016/4705709



Research Article **High-Voltage Converter for the Traction Application**

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Received 28 March 2016; Accepted 29 May 2016

Academic Editor: Pavol Bauer

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High-voltage converter employing IGCT switches ($V_{DC} = 2800 \text{ V}$) for traction application is presented. Such a power traction drive operates with an unstable input voltage over $2000 \cdots 4000 \text{ V}$ DC and with an output power up to 1200 kW. The original power circuit of the high-voltage converter is demonstrated. Development of the attractive approach to designing the low-loss snubber circuits of the high-frequency IGCT switches is proposed. It is established on the complex multilevel analysis of the transient phenomena and power losses. The essential characteristics of the critical parameters under transient modes and the relation between the snubber circuit parameters and the losses are discussed. Experimental results for the prototype demonstrate the properties of new power circuit. The test results confirm the proposed high-voltage converter performance capability as well as verifying the suitability of the conception for its use in the Russian suburban train power system and other high-voltage applications.

1. Introduction

Nowadays, most suburban trains in Russia have 2 head carriages, 5 or 6 motor carriages, and 3 or 4 auxiliary carriages [1]. Thus suburban train consists from 10 or 12 carriages. The traction driver is mounted at every second van of the train. It has nominal output power of 1200 kW at the unstable supply voltage ($U_s = 2000 \cdots 4000 \text{ V DC}$) in the contact network. Each traction drive supplies 4 brushed electric DC motors, which are connected in series. Used DC motors have a rated voltage of 750 V DC and nominal power of 250 kW.

Each traction drive contains contactor equipment and 18-item power circuit breakers and power starting resistors, which carry out start-up and regulation of the train speed. Numerous efforts to use semiconductor power traction drive instead of obsolete and unserviceable 18-item power circuit breakers with power starting resistors were not successful.

The difficulties of designing semiconductor power highvoltage converter for suburban trains in Russia are the following:

(i) The wide range of input voltages (from 2000 V up to 4000 V DC) with possible short single impulses up to 5000 V DC and with duration up to 10 ms.

- (ii) The wide range of environment temperature (from minus 50°C up to plus 45°C) and presence of high humidity, frost, and hoarfrost.
- (iii) The absence of high-frequency high-voltage power semiconductor devices and capacitors and other elements, which are required to solve these problems.

It is known that using the high-frequency principle of the electrical energy transformation is an effective and attractive mean for the power converters. It provides the advantage of reducing their weight, sizes, and cost. However, the use of high operating frequency for the power converters leads to the number of simultaneous problems. The important problem is related to the defence circuits of the power switches where the power losses are increasing in conformity with the frequency rise.

It should be noted that total losses in defence circuits for the converters of the Russian suburban trains are much higher because of the high supply voltage $2000 \cdots 4000 \text{ V DC}$ [2–4]. Owing to this high-voltage level the power losses are increasing $10 \cdots 30$ times in comparison with supply voltage 750 V DC or 1500 V DC.

Thus, the development of the defence circuits in such converter application is prime importance. Thereto, during the design process of defence circuits design, it is necessary to solve two conflicting problems. The first one is to provide normal operation for the semiconductor devices and could be solved by increasing of the components of the snubber circuit. The second problem is to minimize the losses in the protection circuit and should be solved by reducing the values of the parameters of the snubber circuit. The authors suggest a compromise solution of these problems.

Thus the described difficulties in designing a power traction drive require unusual approaches and decisions in designing high-voltage converter as a system, as well as in choosing power device and snubber circuits, control systems, and so forth. In this paper the authors are offered new power high-voltage high-frequency converter for traction drive employing IGCT switches ($V_{\rm DC}$ = 2800 V).

2. The Power Circuit of the Proposed High-Voltage Converter

As noted, the required output power of the high-voltage converter is 1200 kW. However the maximum power of the traction drive, which is equal to the multiplication of the peak current after the input smoothing filter and maximum input voltage, must be not less than 1700 kW because of the wide range of voltages in the contact network (from 2000 V up to 4000 V DC). It is obvious that the design of highly reliable and relatively cheap traction drive for such power and high-voltage can be conducted only on the base of high-frequency power IGCT switches.

To get the high level of traction drive responsibility, it is necessary to specify very rigid requirements for the reliability of the power converter operation. Therefore it is thought to be reasonable to choose such principle of the work of the power circuit, which could provide the following:

- (i) The power semiconductor devices will have the best working conditions, particularly during transient processes.
- (ii) The control of the power high-voltage converter based on the rigid algorithm (independent from input voltage level, load value, etc.) must have a much higher fraction than control based on the flexible algorithm.

After careful consideration of existing decisions and methods, a power Pulse Width Modulation (PWM) high-voltage converter was chosen [2, 4–8]. The open input of the converter makes the output characteristic rigid and, accordingly yields more simplifier control. The PWM technology for power high-voltage converter operating at constant frequency improves operation under no-load.

The first one is to provide normal operation for the semiconductor devices and could be solved by increasing of the components of defence circuits. The second problem is to minimize the losses in the protection circuit and should be solved by reducing the values of the parameters of defence circuits. The parameters of the defence circuits depend on choosing the power self-commutated devices. Therefore specific technical requirements and properties of

TABLE 1: Properties and parameters of power high-voltage semiconductor devices.

	GTO	IGCT	ETO	IGBT
Ratings	3000 A	4000 A	1000 A	1200 A
	$6000\mathrm{V}$	$4500\mathrm{V}$	$4500\mathrm{V}$	3300 V
$V_{\rm sat}$, V	1.7	1.4	2.6	2.4
$E_{\rm off}$, J	1.20	1.08	0.96	0.72
$E_{\rm on}$, J	0.12	0.11	0.10	0.12
W_c	High	Middle	Low	Low

the power semiconductor devices are considered [2, 6, 9–13]. Some of them are the following:

- (i) High current (rms, average, peak, and surge) and voltage (peak repetitive, surge, and DC-continuous).
- (ii) Low losses (conduction and switching).
- (iii) High reliability (low random failures, high power and temperature cycling, and high blocking stability).

An important quality is improved robustness and low device coast.

By output current ($I_{out} = 400 \text{ A}$) and supply voltage ($V_s = 2000 \text{ V}$) properties parameters of power high-voltage semiconductor devices such as GTO (Gate Turn-off Thyristor), IGCT (Integrated Gate-Commutated Thyristor), ETO (Emitter Turn-off Thyristor), and IGBT (Insulated Gate Bipolar Transistor) are analyzed for Russian suburban train applicationand summarised in Table 1, where

 $E_{\rm off}$ and $E_{\rm on}$ are turn-off and turn-on energy switching losses over one period;

 $V_{\rm sat}$ is voltage saturation of semiconductor switch;

 W_c is power consumption of control system.

The best parameters of considered power semiconductor devices are in bold font. According to the above-described requirements IGCT devices are selected for traction highvoltage converter of suburban trains.

As a result of the completed analysis and design procedures the original basic power circuit of the traction driver for Russian suburban train is created. Only last improvements in modern semiconductor technique have given possibilities to design and create this scheme in real conditions. This circuit can realize as well drive mode as a mode of dynamic break for train.

In Figure 1 the original basic power circuit for the drive mode that gives to train forces for movements is shown. Let us give a short description of functional blocks from this circuit:

*A*1: the fast circuit breaker executing a protection of all blocks from over current.

A2: the input filter decreasing an influence of the proposed power traction drive to network power supply.

A3 and A4: power modules including two IGCT (VS1 and VS2) as a semiconductor switches.



FIGURE 1: The basic power circuit for the drive mode.

A5: the block of brake resistors.

*A*6: the switches block executing the switching of the basic power circuit for the different modes.

A7: the auxiliary supply of excitation windings.

*K*1: the contactor which implements the brake mode by low speed of the train.

L3 and L4: chokes decreasing ripple of the motor current.

 $M1 \cdots M4$: brushed electric DC motors for 750 V DC every one.

 $OB1 \cdots OB4$: excitation windings of traction brushed electric DC motors $M1 \cdots M4$.

At the driver mode the control system of high-voltage converter commutes power semiconductor switches VS1 of modules A3 and A4 with using pulse width modulation (PWM). When power semiconductor switches VS1 of modules A3 and A4 are turned on (so-called pulse), then the power current flows as described in the following: the positive potential of the high-voltage supply ($2000 \cdots 4000 \text{ V DC}$), the fast circuit breaker A1, the input filter A2, the semiconductor switch VS1 of the module A3, the choke L3, traction motors M1 and M2, the switch S1 of the block A6.1, excitation windings OB1 and OB2, switch S6 of the block A6.2 and S3 of the block A6.1, excitation windings OB3 and OB4, the switch S8 of the block A6.2, traction motors M4 and M3, the choke L4, the semiconductor switch VS1 of the module A4, and the ground of the high-voltage supply.

When power semiconductor switches VS1 of modules A3 and A4 are turned off (so-called pause), then chokes L3 and L4 and excitation windings $OB1 \cdots OB4$ become a voltage supply and the power current flows by the following two ways. The first way: the positive potential EMF of the excitation winding *OB*2, the switch *S*6 of the block *A*6.2, the diode *VD*2 of the module *A*3, the choke *L*3, traction motors *M*1 and *M*2, the switch *S*1 of the block *A*6.1, and the negative potential EMF of the excitation winding *OB*1.

The second way: the positive potential EMF of excitation winding *OB*4, the switch *S*8 of the block *A*6.2, traction motors *M*4 and *M*3, the choke *L*4, the diode *VD*2 of the module *A*4, the switch *S*3 of the block *A*6.1, and the negative potential EMF of the excitation winding *OB*3.

In order to increase or decrease the rotational frequency of traction brushed electric DC motors $M1 \cdots M4$, the control system of the high-voltage converter has to increases or decreases the width pulses semiconductor switches VS1 of modules A3 and A4. Thus the suburban train controls the speed.

If the suburban train has to move backwards, then the control system of high-voltage converter has to open switches S1, S3, S6, and S8 and has to close switches S2, S4, S5, and S7 of the blocks A6.1 and A6.2. In this case, when power semiconductor switches VS1 of modules A3 and A4 are turned on the power current flows in the following way: the positive potential of the high-voltage supply ($2000 \cdots 4000 \text{ V DC}$), the fast circuit breaker A1, the input filter A2, the semiconductor switch VS1 of module A3, choke L3, traction motors M1 and M2, switch S5 of the block A6.2, excitation windings OB2 and OB1, switches S2 and S7 of the blocks A6.1 and A6.2, excitation windings OB4 and OB3, the switch S4 of the block A6.1, traction motors M4 and M3, choke L4, the power semiconductor VS1 of module A4, and the ground of the high-voltage supply.

When power semiconductor switches VS1 of modules A3 and A4 are turned off, then the chokes L3 and L4 and



FIGURE 2: The basic power circuit for the brake mode.

excitation windings $OB1 \cdots OB4$ become a voltage supply and the power current flows by the following two ways.

The first way: the positive potential EMF of the excitation winding *OB*1, switch *S*2 of block *A*6.1, diode *VD*2 of module *A*3, choke *L*3, traction motors *M*1 and *M*2, switch *S*5 of block *A*6.2, and the negative potential EMF of the excitation winding *OB*2.

The second way: the positive potential EMF of the excitation winding *OB3*, switch *S*4 of block *A*6.1, traction motors *M*4 and *M*3, choke *L*4, diode *VD*2 of module *A*4, switch *S*7 of block *A*6.2, and the negative potential EMF of the excitation winding *OB*4.

In Figure 2 the basic power circuit for the brake mode that allows train to stop using the energy of traction brushed electric DC motor rotations without using the brake pads is shown.

If the suburban train has to stop, then the control system of high-voltage converter has to close switches $S5 \cdots S8$ of the blocks A6.2 and has to open switches $S1 \cdots S4$ of the blocks A6.1.

It is clear that changing switches $S1 \cdots S8$ of the blocks A6.1 and A6.2 is one problem. The flowing power current evaluates $300 \cdots 400$ A and there is a dangerous consequence of it. On this reason commute of switches of the blocks A6.1 and A6.2 has to execute under zero current. In this case the EMF of power motors is equal to zero and brake forces of the train are equal to zero too. To eliminate the control system has to turn on the auxiliary supply A7 of excitation windings $OB1 \cdots OB4$ that give initial current for train braking torque.

In this situation traction motors $M1 \cdots M4$ become a high-voltage supply of EMF.

At the brake mode the control system high-voltage converter commutes power semiconductor switches VS2 of

modules A3 and A4 with using pulse width modulation (PWM). When power semiconductor switches VS2 of modules A3 and A4 are turned on, the power current flows by the following two ways.

The first way: the positive potential EMF of the traction motor *M*1, choke *L*3, the semiconductor switch *VS*2 of module *A*3, switches S6 and S5 of block *A*6.2, and the negative potential EMF of the traction motor *M*2.

The second way: the positive potential EMF of the traction motor M4, switches S8 and S7 of block A6.2, the semiconductor switch VS2 of module A4, choke L4, and the negative potential EMF of the traction motor M3.

When power semiconductor switches VS2 of modules A3 and A4 are turned off, then the power current flows in the following way: the positive potential EMF of the traction motor M1, choke L3, diode VD1 of module A3, the input filter A2, the fast circuit breaker A1, the positive potential of the high-voltage supply (2000 \cdots 4000 V DC), the ground of the high-voltage supply, diode VD1 of the module A4, choke L4, traction motors M3 and M4, switches S8, S7, S6, and S5 of block A6.2, and traction motor M2.

By reducing the speed of the train the control system of high-voltage converter increases the pulse width of the semiconductor switches VS2 of modules A3 and A4. At low speed of the train the control system of high-voltage converter closes contactor K1. When power semiconductor switches VS2 of modules A3 and A4 are turned on, the power current flows by the following two ways.

The first way: the positive potential EMF of the traction motor M1, choke L3, semiconductor switch VS2 of module A3, switches S6 and S5 of block A6.2, and the negative potential EMF of the traction motor M2.



FIGURE 3: The basic power circuit of modules A3 and A4.

The second way: the positive potential EMF of the traction motor *M*4, switches S8 and S7 of block *A*6.2, the semiconductor switch *V*S2 of module *A*4, choke *L*4, and the negative potential EMF of the traction motor *M*4.

When power semiconductor switches VS2 of modules A3 and A4 are turned off, then the power current flows in the following way: the positive potential EMF of the traction motor M1, choke L3, diode VD1 of module A3, contactor K1, block A6 of brake resistors, diode VD1 of module A4, choke L4, traction motors M3 and M4, switches S8, S7, S6, and S5 of block A5, and the traction motor M2.

Thus the train stops without using the brake pads.

The important advantage of the proposed power circuit of the high-voltage converter is that power semiconductor switches *VS*1 and *VS*2 can be used with a $V_{\rm DC} = V_{sm}/2$, where V_{sm} is maximum voltage supply (4000 V DC).

3. Simulation and Design of Energy Efficient Snubber Circuits

As a result of the analysis and design procedures the basic power circuit of modules *A*3 and *A*4 is selected and presented in Figure 3.

It contains two power semiconductor switches (VS1 and VS2), two power diodes (VD1 and VD2), the clamping inductor L1 with the diode VD3 and the resistance R1, snubber capacitors (C1 and C2) with charging diodes (VD4 and VD5), and discharging, resistances (R2 and R3). Electrical components L1, C1, C2, VD3…VD5 and R1…R3 form snubber circuits of semiconductor switches VS1 and VS2.

As power semiconductor switches VS1 and VS2 and power diodes VD1 and VD2 are selected and applied, the devices 5SHY35L4505 and 5SDF10H4502 were chosen as VS1 and VS2 and VD1 and VD2 correspondingly.

The clamping inductor L1 limits the value of the instantaneous surge current (I_s) and the rate of the rise of on-state surge current (dI_s/dt) of the power semiconductor switches VS1 in emergency regimes. The resistance R1 limits the reverse voltage of the clamping inductor L1, while dissipating



FIGURE 4: The surge current.

the clamping energy. The antiparallel diode VD3 provides the instantaneous clamping action, due to its fast forward characteristic.

The snubber capacitors C1 accumulate a switching energy and, accordingly, limit the rate of rise of off-state voltage over power semiconductor switch VS1 for the drive mode. The charging diode VD4 is connected in series with snubber capacitor C1 shunt discharging resistor R2 in the forward direction. The discharging resistor R2 limits the discharge current of the C1 at turn-on of semiconductor switch VS1.

The snubber capacitors C2 accumulate a switching energy and, accordingly, limit the rate of rise of off-state voltage over power semiconductor switch VS2 for the brace mode. The charging diode VD5 is connected in series with snubber capacitor C2 shunt discharging resistor R3 in the forward direction. The discharging resistor R3 limits the discharge current of the C2 at turn-on of semiconductor switch VS2.

The accuracy of simulation results is achieved due to careful study of real transients in power semiconductor devices VS1 and VS2 (5SHY35L4505) and VD1 and VD2 (5SDF10H4502) for the following conditions: $V_s = 2000$ V; 3000 V and 4000 V DC; $I_{out} = 200$ A; 350 A and 400 A. The CASPOC software for the simulation is used.

The comprehensive analysis of the transient is carried out for a wide range of different values of supply voltage, load, clamping inductor *L*1, clamping resistance *R*1, snubber capacitors (*C*1 and *C*2), and discharging resistances (*R*2 and *R*3). It allows developing the simplified single-operating engineering algorithm for the estimation and selection of the proper defence circuit parameters with the initial constraints and lower power losses.

3.1. Design of the Clamping Inductor. The maximum values of the surge current I_s , the rate of the rise of on-state surge current dI_s/dt , and repetitive peak voltage V_m on the off-state the power semiconductor switch VS1 are used as the initial data. These values are defined in accordance with a desired reliability of high-voltage converter.

The analysis of the transient shows that in case of a rise of the supply voltage and load current almost all parameters for the transient have got a tendency to change the conditions for the power semiconductor switch VS1 to the worse direction. Also the analysis shows that the maximum values of the surge current (Figure 4), the rate of the rise of on-state surge current, maximum nonrepetitive peak voltage, and the rate of rise off-state voltage dV/dt over the power semiconductor switch VS1 in the emergency regimes are decreased when the inductor values of L1 are increased. The maximum voltage (V_z) on the turn-off power semiconductor switch VS1 and maximum peak voltage (V_m) on the off-state power semiconductor switch VS1 in normal operation are reduced slightly.

During its turn, the energy losses in the clamping resistance R1 over one period are increased, when the inductor values of L1 are increased. Accordingly it is limiting the values of the clamping inductor L1.

For the proper synthesis of the energy efficient snubber circuits it is desirable to select the minimum possible inductor *L*1 values and the following design strategy is recommended.

(1) The auxiliary variable is calculated:

$$B = \frac{I_s - I_m}{T_d},\tag{1}$$

where T_d is value of minimum fall time.

- (2) The maximum value of the dI_s/dt and B with its further equaling to A is selected.
- (3) The inductor *L*1 value is calculated:

$$L1 = \frac{V_m - (I_s - I_m) \cdot r}{2 \cdot A},\tag{2}$$

where *r* is minimum value of total resistance of the circuit in the emergency regimes.

The obtained values of the clamping inductance allow maintaining the minimum losses over one period in the clamping resistance R1 in accordance with the requested value B and task parameters I_s and I_m and dI_s/dt power semiconductor switch VS1.

3.2. Design of the Clamping Resistance. The obtained value of the clamping inductance L1 and the maximum values of the repetitive peak voltage V_m on the off-state power semiconductor switch VS1 are used as the initial data.

The analysis of the transient shows that maximum peak voltage V_m on the off-state semiconductor switch VS1 is decreased when the values of the clamping resistor R1 are reduced (Figure 5). In its turn, the rate of the rise of current dI_{vs}/dt of the semiconductor switch VS1 and the average current of the diode VD3 are increased when the values of the clamping resistor are reduced.

In order to select optimal clamping resistor the following design procedure is used.

(1) The auxiliary variables are calculated:

$$R_{a} = \frac{V_{m} - V_{sm}}{4 \cdot I_{m}};$$

$$R_{b} = \frac{V_{ms} - V_{sm}}{4 \cdot I_{sm}};$$

$$R_{c} = \frac{Q}{L1} - R_{vd} - R_{L2},$$
(3)



FIGURE 5: The maximum peak voltage.

where *Q* is task time-constant of the clamping circuit; R_{vd} and R_{L2} are values of the resistance of the diode *VD3* and clamping inductor *L2*.

(2) The minimum value of the R_a , R_b , and R_c with its further equaling to clamping resistor R1 is selected.

3.3. Design of the Snubber Circuits. The parameters of the L2 and R1 are used as the initial data for the simulation and further selection of the snubber capacitor C1 and discharging resistor R2. Additionally, the maximum values of the V_m and V_{ms} and the duration (T_{cm}) and amplitude (I_{cm}) of the discharge current are used as the initial data.

The analysis of the transient shows that the increase of snubber capacitor values leads to the power loss growth in the discharging resistors R2 over one period. Therefore the low-loss energy regimes in the snubber circuits occur for the lowest values of the snubber capacitors C2. During its turn, the increase of the snubber capacitor values leads to the growth of the transient duration. Also the analysis shows that the amplitude I_c of discharge current is increased, but the duration T_c is decreased, when the values of the resistor R2 are decreased.

For selecting the minimum possible capacitors values the following design strategy is recommended.

(1) The auxiliary variable is calculated:

$$C_m = \frac{2 \cdot I_{sm} \cdot T_{cm}}{V_{ms} - V_{sm}}.$$
(4)

(2) The auxiliary variables are calculated:

$$R_m = \frac{T_{cm}}{2 \cdot C_m} - R_{vs},$$

$$R_{cm} = \frac{V_{sm}}{I_{cm}} - R_{vs},$$
(5)

where R_{vs} is value of the resistance of the power semiconductor switch *VS*1.

(3) The optimum of the R_m and R_{cm} with its further equaling to R2 is selected.



FIGURE 6: The current waveform.

- (4) Dependencies of the maximum values of the instantaneous surge current I_s and the rate of the rise of on-state surge current dI_s/dt of the switch VS1 in the emergency regimes are simulated. The value of the clamping inductance L1 are defined according to the requirements I_{sm} and dI_{sm}/dt and results of the CASPOC simulation.
- (5) The dependencies of the maximum values of the instantaneous repetitive peak voltage on the off-state power semiconductor switch VS1 are simulated. Value of the clamping resistor R1, snubber capacitor C2, and snubber resistor R2 are defined according to the requirements V_m and V_{ms} and results of the CASPOC simulation.

The values of snubber capacitor C3 and snubber resistor R3 of the power semiconductor switch VS2 are determined in the same way, taking into account inductance chokes L3 and L4.

The obtained values of the defence circuits allow maintaining the minimum losses over one period in the resistor R1 and snubber resistors R2 and R3 in accordance with the requirement of the task parameters V_m , V_{ms} , I_{sm} , dI_{sm}/dt , and I_{cm} .

4. Computer Simulation

Transients, quasi-steady-states and emergency mode of the operation are passed using CASPOC software. The comprehensive analysis of the transient is considered out for a wide range of the supply voltage and parameters variation of the load, clamping inductor, clamping resistance, snubber capacitors and discharging resistances. The current and voltage curves of the proposed high-voltage converter are received and analyzed as a result of computer simulation. For example, the simulation results of the current waveform (*i*) of the power semiconductor switch *VS2* are shown in Figure 6 for starting movement of the train at the supply voltage 3000 V and limiting current 400 A.

As the simulation result, the suburban train speed (ν , km/h) dependence as the functions of the way (L, m) is shown in Figure 7.

Also CASPOC was used for examination of the interference of proposed high-voltage converter into the central

TABLE 2: Parameters of elements of snubber circuits.



FIGURE 7: The speed waveform of the train.

railways emergency system and wire communications. Computer simulation of electromagnetic processes show that the maximal amplitudes of the input current harmonic components appear at the maximal permissible loads (400 A) and the input voltage (4000 V). The maximal values of the harmonic component amplitudes (equal to 77 mA, 2790 Hz) are not exceeding the permissible values.

As a result of the comprehensive analysis the optimum parameters of elements of snubber circuits of semiconductor switches *VS*1 and *VS*2 are given in Table 2.

5. Sample Description

The skilled sample of the power module for Russian suburban trains is designed. In the design sample was decided to be applied to power fast IGCT devises 5SHY35L4505 (as semiconductor switches VS1 and VS2) and power fast diodes 5SDF10H4502 (as diodes VD1 and VD2) to increase the working frequency of the proposed high-voltage converter and, accordingly, to decrease the total weight and sizes of the power module. Chosen power IGCT has turn-off time at most 2 μ s with repetitive peak voltage in the off state 4500 V, critical rate of voltage rise in the on state 500 A/ μ s. Chosen power diodes with repetitive pulse reverse voltage 4500 V and forward current 2000 A (rms) have reverse recovery time at most 1 μ s.

Clamping inductors L1 of the power module are chosen to be air-core. This allowed their normal functioning in case of emergency modes of the considered high-voltage converter, when the short-time shock current exceeds $2 \div 3$ kA. This value greatly exceeds nominal current and makes the application of iron-core clamping inductor inefficient. External diameter of the clamping inductor L1 of the power module is 70 mm, internal diameter is 50 mm, and height is 50 mm.

The design power module of the proposed converter is shown in Figure 8. It has forced oil cooling. Its dimensions are



FIGURE 8: The power module.



FIGURE 9: The voltage waveforms of the power switches VS1 (curve 1) and VS2 (curve 2).

570 mm, 730 mm, and 550 mm and weight does not exceed 90 kg.

Complete tests of the power module are conducted in the high-voltage experimental laboratory for checking the accuracy of the mathematical model. As an example, the test results of the voltage waveforms of the power switches *VS*1 (curve 1) and *VS*2 (curve 2) are presented in Figure 9 at the supply voltage 4000 V and limit current 200 A.

The surface temperatures of electrical components of the power module are also measured. The maximum surface temperature excess over the ambient temperature is fixed for the clamping inductor *L*1. It is equal to 77.5° C. The power semiconductor switches *VS*1 and *VS*2 have a maximum temperature excess of 71° C.

6. Conclusion

As a result of the completed analysis and design procedures the original high-voltage converter of the traction driver for Russian suburban train is proposed. The authors developed the detailed algorithm for the calculation and selection of the elements of the low-loss snubber circuits for considered converter. This algorithm is used during the preliminary design stage of the traction converters with nominal output power 1200 kW (maximum power 2100 kW) at the unstable input voltage 2000...4000 V DC. It allowed reducing the power losses in the snubber circuits on 23%. For this reason the traction driver should incorporate the features of welldesigned snubber circuits to insure power converter device protection regardless of wide range of either supply or load conditions.

The important advantage of the proposed power circuit of the high-voltage converter is that power semiconductor switches VS1 and VS2 can be used with a $V_{\rm DC} = V_{sm}/2$, where V_{sm} is maximum voltage supply (4000 V DC).

Extensive tests of the designed converter conducted in the high-voltage laboratory demonstrated the high accuracy of the used software, and the correctness of the chosen basic power elements. The complex tests have shown that the considered high-voltage converter operates stably at steadystate conditions over a whole range of the input voltages and permissible loads (including their discrete variations) and at the starting mode and turn-off of the loads.

The presented results are very interesting for the designers of power high-voltage converters and traction drive.

Competing Interests

The authors declare that there are no competing interests regarding the publication of this paper.

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